

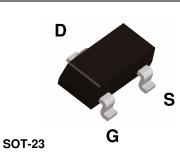
BSS138 N-Channel Logic Level Enhancement Mode Field Effect Transistor

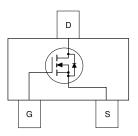
General Description

These N-Channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

Features

- 0.22 A, 50 V. $R_{DS(ON)}=$ 3.50 @ $V_{GS}=$ 10 V $R_{DS(ON)}=~6.0\Omega$ @ $V_{GS}=4.5$ V
- High density cell design for extremely low $R_{\text{DS}(\text{ON})}$
- Rugged and Reliable
- Compact industry standard SOT-23 surface mount package





Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		50	V	
V _{GSS}	Gate-Source Voltage		±20	V	
ID	Drain Current – Continuous	(Note 1)	0.22	А	
	– Pulsed		0.88		
PD	Maximum Power Dissipation	(Note 1)	0.36	W	
	Derate Above 25°C		2.8	mW/°C	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds		300	°C	
Therma	I Characteristics				
R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1)	350	°C/W	

Device Marking	Device	Reel Size	Tape width	Quantity
SS	BSS138	7"	8mm	3000 units

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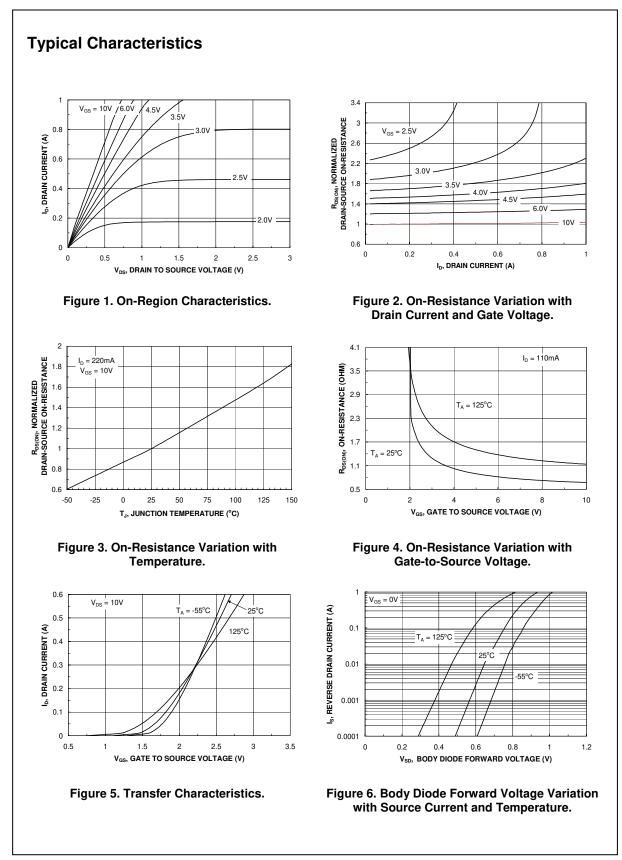
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics		1	1	<u> </u>	
3V _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	50			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		72		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 50 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			0.5	μA
		$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V} \text{ T}_{J} = 125^{\circ}\text{C}$			5	μA
		$V_{\text{DS}} = 30 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			100	nA
GSS	Gate-Body Leakage.	$V_{GS}=\pm 20~V, ~~V_{DS}=0~V$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	0.8	1.3	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 1$ mA,Referenced to 25°C		-2		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = 10 V$, $I_D = 0.22 A$		0.7	3.5	Ω
	On-Resistance	$V_{GS} = 4.5 \text{ V}, \qquad I_D = 0.22 \text{ A}$		1.0	6.0	
D(on)	On-State Drain Current		0.2	1.1	5.8	А
JFS	Forward Transconductance	$V_{DS} = 10V, I_D = 0.22 A$	0.12	0.5		S
-	Characteristics		-		<u> </u>	
C _{iss}	Input Capacitance	$V_{DS} = 25 V$, $V_{GS} = 0 V$,		27		pF
Coss	Output Capacitance	f = 1.0 MHz		13		pF
Crss	Reverse Transfer Capacitance		-	6		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		9		Ω
Switchin	g Characteristics (Note 2)			1	<u> </u>	
d(on)	Turn–On Delay Time	$V_{\text{DD}} = 30 \text{ V}, \qquad I_{\text{D}} = 0.29 \text{ A},$		2.5	5	ns
r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		9	18	ns
d(off)	Turn–Off Delay Time			20	36	ns
f	Turn–Off Fall Time			7	14	ns
\mathbf{Q}_{g}	Total Gate Charge	$V_{DS} = 25 V$, $I_D = 0.22 A$,		1.7	2.4	nC
, 2 _{gs}	Gate-Source Charge	$V_{GS} = 10 \text{ V}$		0.1		nC
Q _{qd}	Gate–Drain Charge		-	0.4		nC
Ū.	ource Diode Characteristics	and Maximum Batings		1	<u> </u>	
s	Maximum Continuous Drain–Source				0.22	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 0.44 A$ (Note 2)		0.8	1.4	V

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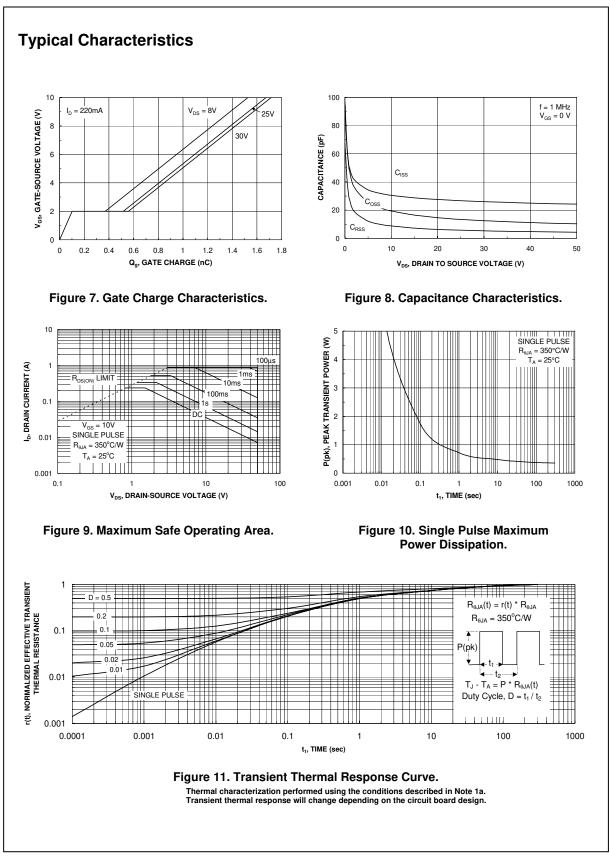
 a) 350°C/W when mounted on a minimum pad..

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%



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